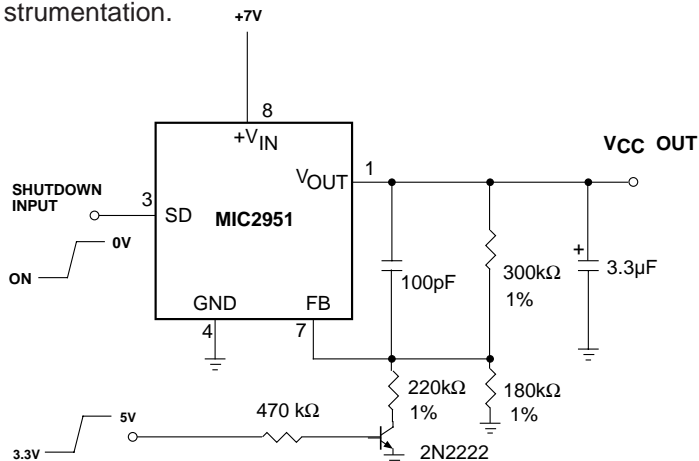


## Using Low Current LDO Regulators

**by Bob Wolbert**

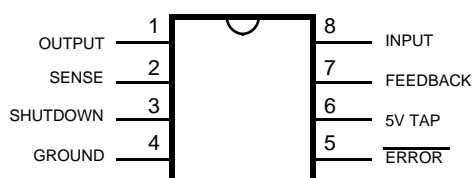
## General Description

The MIC2951 brings the benefits of linear regulation to surface mountable packaging. High accuracy, high efficiency, very low ripple, and excellent protective features are combined into a useful device for laptop/notebook computers, communications equipment, and battery operated instrumentation.

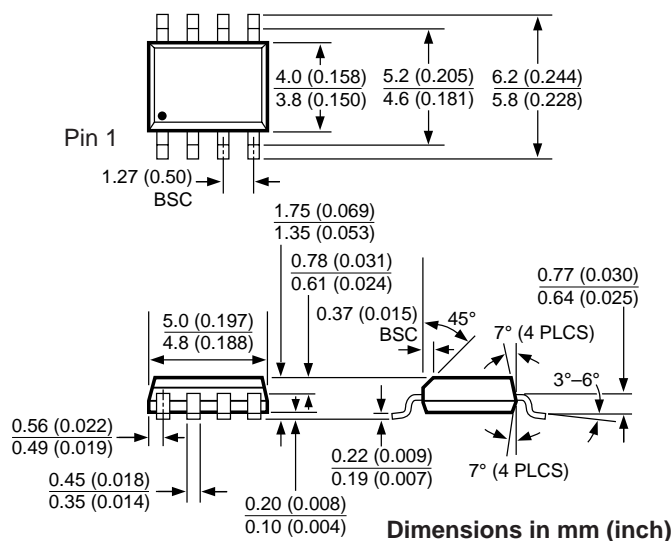


### MIC2951 Configured as a selectable 3.3V or 5.0V output regulator.

## Pin Configuration



## Package Dimensions



## Features

- High accuracy +5V or adjustable output voltage
- Extremely small size; up to 150mA output current
- Low dropout voltage and quiescent current
- Thermal and over-current protection
- Error flag warns of output dropout
- Logic-controlled electronic shutdown

## MIC Versus LP Benefits

- Lower dropout voltage
- 150mA output current vs. 100mA
- One-sixth the ground current
- Reverse battery protection for load
- Survives automotive "Load Dump" transient (60V)

## Ordering Information

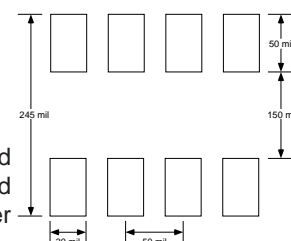
Part Number	Temperature Range	Package	Accuracy
LP2951-02BM	−40°C to + 85°C	8-Pin SOIC	0.5%
LP2951-03BM	−40°C to + 85°C	8-Pin SOIC	1.0%
MIC2951-02BM	−40°C to + 85°C	8-Pin SOIC	0.5%
MIC2951-03BM	−40°C to + 85°C	8-Pin SOIC	1.0%

## Thermal Considerations

## Part I. Layout

The MIC2951-02/03BM (8-pin surface mount package) has the following thermal characteristics when mounted on a single layer copper-clad printed circuit board.

<b>PC Board Dielectric</b>	$\theta_{JA}$
FR4	160°C/W
Ceramic	120°C/W



Multi-layer boards having a ground plane, wide traces near the pads, and large supply bus lines provide better thermal conductivity.

The "worst case" value of 160°C/W assumes no ground plane, minimum trace widths, and a FR4 material board.

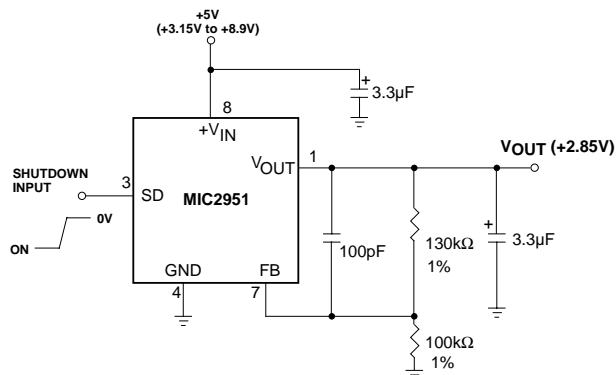
**Minimum recommended board pad size**

## Part II. Nominal Power Dissipation and Die Temperature

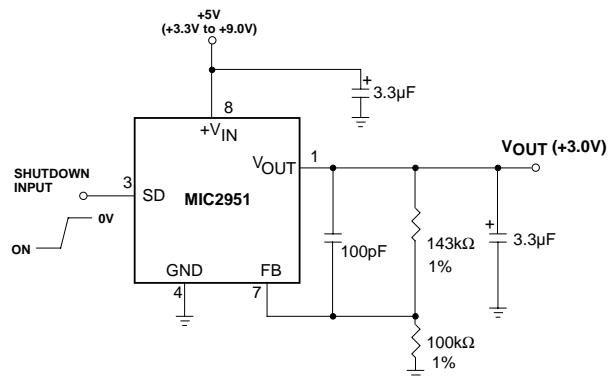
The MIC2951-02/-03BM at a 25°C ambient temperature will operate reliably at up to 625mW power dissipation when mounted in the "worst case" manner described above. At an ambient temperature of 55°C, the device may safely dissipate 440mW. These power levels are equivalent to a die temperature of 125°C, the recommended maximum temperature for non-military grade silicon integrated circuits.

## Typical Applications

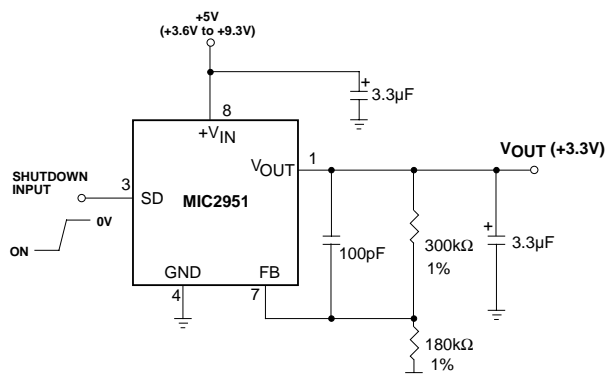
**MIC2951-02/-03BM** common voltage applications. Calculations assume 100mA of output current, 25°C ambient temperature, 100% duty cycle, and 160°C/W mounting. The Shutdown Input may be left floating if it is not used.



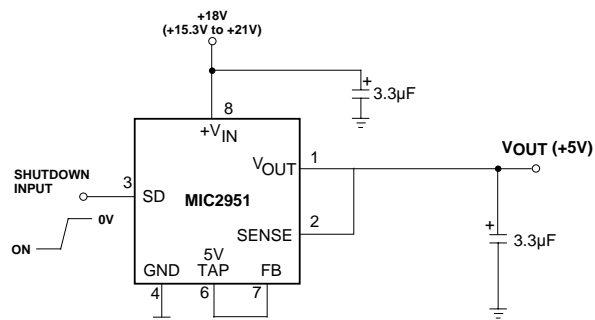
**MIC2951 +2.85V Regulator**



**MIC2951 +3.0V Regulator**

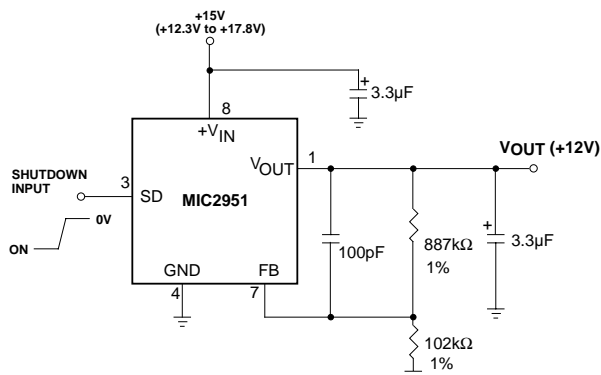


**MIC2951 +3.3V Regulator**

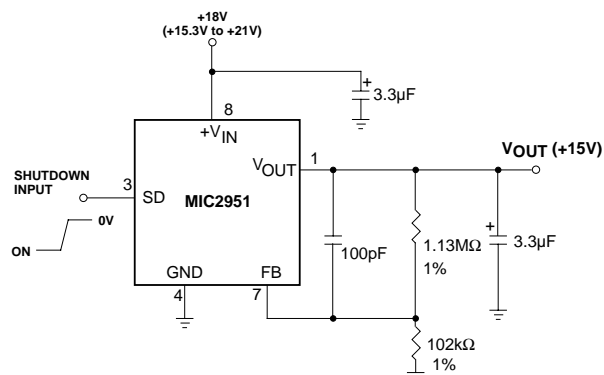


(Note: no external resistors are necessary)

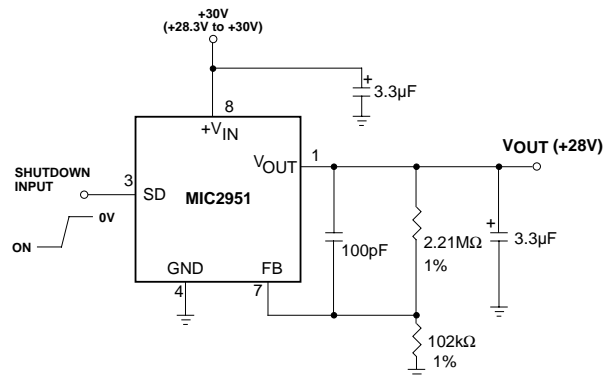
**MIC2951 +5.0V Regulator**



**MIC2951 +12.0V Regulator**



**MIC2951 +15.0V**



**MIC2951 +28.0V Regulator**